Indiana Meat Packers & Processors Association
Scholarship

Awarded by:
Indiana Meat Packers & Processors Association

IMPPA Scholarship:
The IMPPA Scholarship will be given annually in the amount of $1,000.00. This scholarship is available to anyone with connections to the IMPPA. This scholarship is not limited to meat science, and can be used in any accredited school for further education. The scholarship recipient will be announced at the IMPPA Convention. Application must be received by August 31.

Please Mail to: Indiana Meat Packers & Processors Association, Inc. Dewig Meats P.O. Box 186 Haubstadt, IN 47639

Scholarship Criteria and Conditions:
Criteria: High school graduate or accredited diploma
Must show connection to IMPPA
School transcript
Two letters of recommendation
Completed IMPPA scholarship application

Conditions: Attending an accredited school

Scholarship Considerations: Class Ranking
GPA
School and community service
Leadership
Letters of recommendation
Financial need

Scholarship Selection Process:
1. The selection committee will consist of members selected by the Indiana Meat Packers & Processors Board of Directors.

2. The committee will review all applications and criteria.

3. The committee will recommend its decision to the board for final approval.
Indiana Meat Packers & Processors Association
Application
Please print or type

Application Data

Mr. ( )
Ms. ( )

( ) ( ) ( )

( ) ( ) ( )

Permanent Address (Street) (City) (State) (Zip)

Date of Birth (Month, Day, Year) Telephone Number

Parent Data

Name of parents/guardian ______________________

Permanent mailing address of parent/guardian if different from applicant

(Street) (City) (State) (Zip)

Married: Yes  No  Children: Yes  No  Number

Sponsor Information

( ) ( ) ( ) ( )

(Sponsor's Name)

(Street) (City) (State) (Zip)

(Contact Name)

School Data

High School Attended ______________________  Graduation Date: Month_______ Year_______

Address ____________________________ (Street) (City) (State) (Zip) ( )

(Telephone Number)

Name of High School Principal ______________________

Major field of study applicant plans to pursue ______________________
A. Work Experience
Describe your work experience stressing leadership, condition and position during the past 4 years. Indicate dates of employment in each job, approximate number of hours worked each week, position, job description, etc.

B-1. School Activities
List all school activities stressing leadership, condition and position in which you have participated during the past 4 years (e.g., student government, music, sports, exchange programs, etc.) Please list activity and number of years participated.

B-2. Special Awards or Recognitions
Please list all special awards or recognitions stressing leadership, condition and position.

Volunteer and Community Service Activities
Expand on your service to others. Describe the impact that your service has had on you and the community. Service may have been given to your own family, your school, neighborhood, community organization, church/synagogue, etc.
Personal Statement of Goals
(May attach additional sheet)

Make a statement of your plans as they relate to your educational and career objectives and future goals.

Personal statement of need: Please make a statement about any special circumstances that may affect your ability to complete your further education. (Special family circumstances, unusual expenses, financial concerns.)
Transcript Information

High school seniors and students who have completed less than one full semester of post secondary education must include a high school transcript of grades and have the following sections completed by the appropriate school official.

Applicant ranks___________ in class of ____________________ cumulative grade point average __________

PSAT Verbal _____________ Math __________ SAT Verbal _______________ Math __________

ACT Percentiles Composite Score ___________ Math _______________ English____________________

Science Reasoning ___________ Reading _____________

<table>
<thead>
<tr>
<th>School Official's Signature</th>
<th>Date</th>
<th>Title</th>
<th>Telephone Number</th>
</tr>
</thead>
</table>

<table>
<thead>
<tr>
<th>School Address</th>
<th>(Street)</th>
<th>(City)</th>
<th>(State)</th>
<th>(Zip)</th>
</tr>
</thead>
</table>

Indiana Meat Packers & Processors Association Connection

Describe your IMPPA connection.
Additional Information

The parents' current marital status is:  ( ) Single   ( ) Married   ( ) Widowed
                      ( ) Separated  ( ) Divorced

Total number of family members who will be attending a post-secondary school at least 1/2 time during the current school year, including applicant:______________________________

Certification and Signatures

Applicant's Signature

Father's Signature                           Mother's Signature

IMPPA Sponsor Signature

Date completed ____________________________
                   (Month)    (Day)    (Year)